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SICC CO., LTD.

山東天岳先進科技股份有限公司

(A joint stock company incorporated in the People's Republic of China with limited liability)

(Stock Code: 2631)

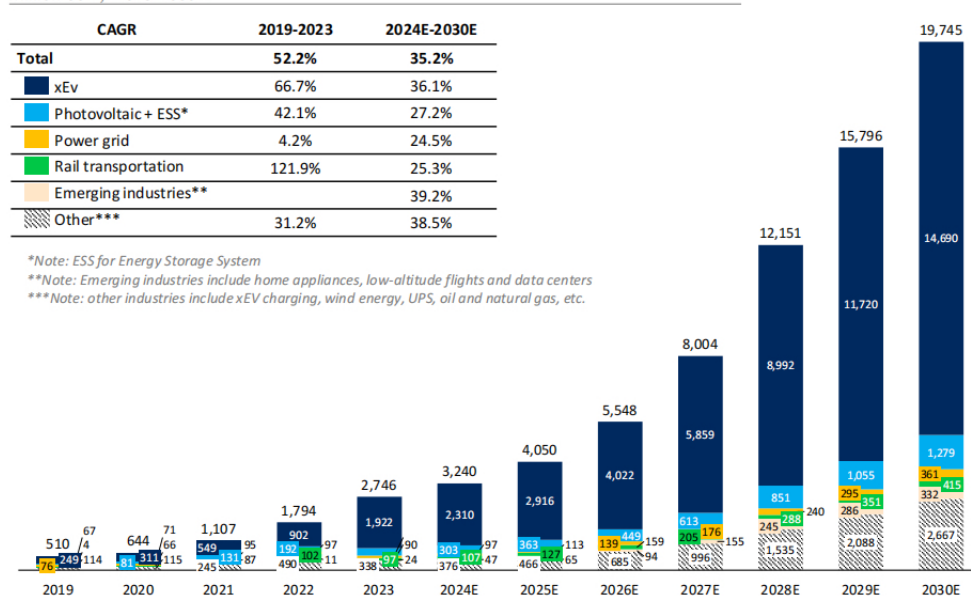
SUPPLEMENTAL ANNOUNCEMENT IN RELATION TO 2025 ANNUAL RESULTS ANNOUNCEMENT

Reference is made to the 2025 Annual Results Announcement (the “**Announcement**”) of SICC CO., LTD. (the “**Company**”) published on 27 March 2026. Unless otherwise stated, capitalised terms used herein shall have the same meanings as defined in the Announcement.

The Company would like to clarify that the three images displayed on pages 19, 20, and 33 of the Announcement should be revised as follows:

Global SiC power semiconductor device market size, in terms of sales revenue

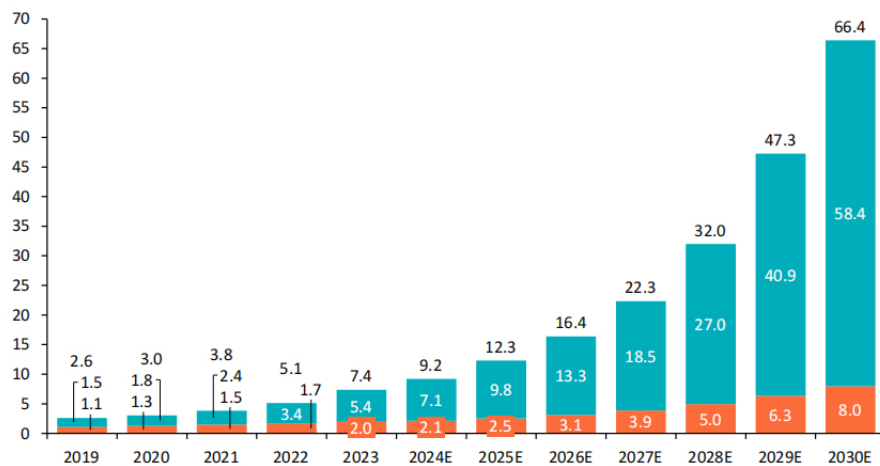
Million USD, 2019-2030E



Global Silicon Carbide Substrate Market, by Sales Revenue

billion RMB, 2019-2030E

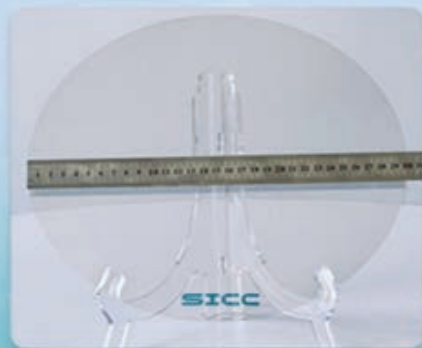
	CAGR	2019-2023	2024E-2030E
Total		29.4%	39.0%
 Conductive silicon carbide substrate		36.7%	42.1%
 Semi-insulating silicon carbide substrate		16.2%	24.6%



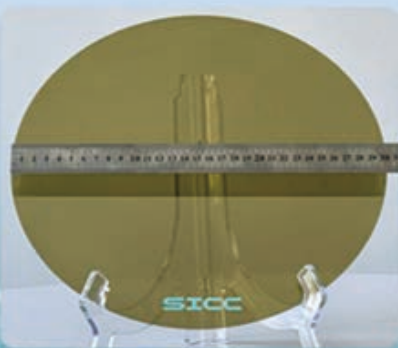
Note: The market size only includes products for external sales, and data of self-produced and self-used products are not included.)

SICC 天岳先进

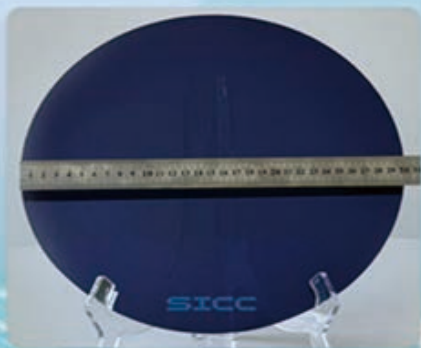
SICC successfully developed 12-inch semi-insulated-type, conductive, P-type substrate



**12-inch high purity
silicon carbide substrate**



**12-inch conductive n-type
silicon carbide substrate**



**12-inch conductive p-type
silicon carbide substrate**

Save for the above, all other information stated in the Announcement remain unchanged.

By order of the Board
SICC CO., LTD.
Mr. Zong Yanmin
Chairman of the Board,
Executive Director and General Manager

Hong Kong, 30 March 2026

As at the date of this announcement, the Board comprises: (i) Mr. Zong Yanmin, Mr. Gao Chao and Mr. Wang Junguo as executive Directors; (ii) Mr. Qiu Yufeng, Ms. Li Wanyue and Mr. Fang Wei as non-executive Directors; and (iii) Mr. Li Honghui, Ms. Liu Hua and Mr. Lai Kwok Hung Alex as independent non-executive Directors.